FAIRCHILD SEMICONDUCTOR™

April 1989
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100328
Low Power Octal ECL/TTL Bi-Directional Translator with Latch

General Description

The 100328 is an octal latched bi-directional translator designed to convert TTL logic levels to 100K ECL logic levels and vice versa. The direction of this translation is determined by the DIR input. A LOW on the output enable input (OE) holds the ECL outputs in a cut-off state and the TTL outputs at a high impedance level. A HIGH on the latch enable input (LE) latches the data at both inputs even though only one output is enabled at the time. A LOW on LE makes the 100328 transparent.

The cut-off state is designed to be more negative than a normal ECL LOW level. This allows the output emitter-followers to turn off when the termination supply is −2.0V, presenting a high impedance to the data bus. This high impedance reduces termination power and prevents loss of low state noise margin when several loads share the bus.

The 100328 is designed with FAST® TTL output buffers, featuring optimal DC drive and capable of quickly charging and discharging highly capacitive loads. All inputs have 50 kΩ pull-down resistors.

Features

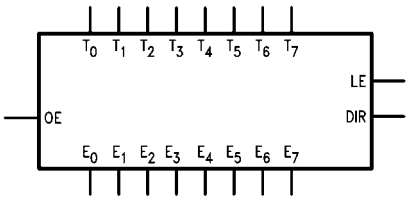
- Identical performance to the 100128 at 50% of the supply current
- Bi-directional translation
- 2000V ESD protection
- Latched outputs
- FAST TTL outputs
- 3-STATE outputs
- Voltage compensated operating range = −4.2V to −5.7V
- Available to industrial grade temperature range

Ordering Code:

Order Number	Package Number	Package Description
100328SC	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
100328PC	N24E	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-010, 0.400 Wide
100328QC	V28A	28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square
100328QI	V28A	28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square Industrial Temperature Range (−40°C to +85°C)

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol



Pin Descriptions

Pin Names	Description
E_0–E_7	ECL Data I/O
T_0–T_7	TTL Data I/O
OE	Output Enable Input
LE	Latch Enable Input
DIR	Direction Control Input

All pins function at 100K ECL levels except for T_0–T_7.

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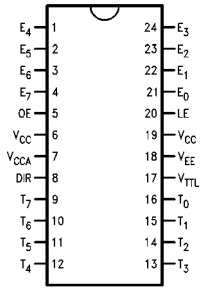
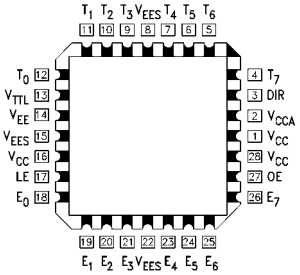
Connection Diagrams

24-Pin DIP/SOIC



28-Pin PLCC



Truth Table

OE	DIR	LE	ECL Port	TTL Port	Notes
L	X	L	LOW (Cut-Off)	Z	
L	L	H	Input	Z	(Note 1)(Note 3)
L	H	H	LOW (Cut-Off)	Input	(Note 2)(Note 3)
H	L	L	L	L	(Note 1)(Note 4)
H	L	L	H	H	(Note 1)(Note 4)
H	L	H	X	Latched	(Note 1)(Note 3)
H	H	L	L	L	(Note 2)(Note 4)
H	H	L	H	H	(Note 2)(Note 4)
H	H	H	Latched	X	(Note 2)(Note 4)

H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care
Z = High Impedance

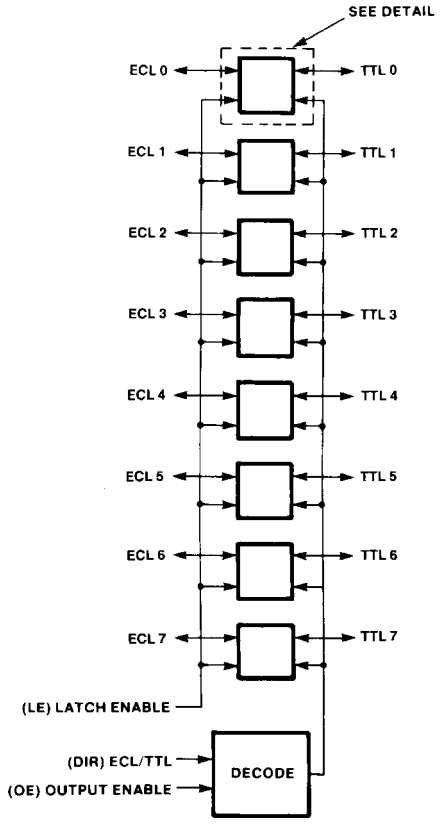
Note 1: ECL input to TTL output mode.

Note 2: TTL input to ECL output mode.

Note 3: Retains data present before LE set HIGH.

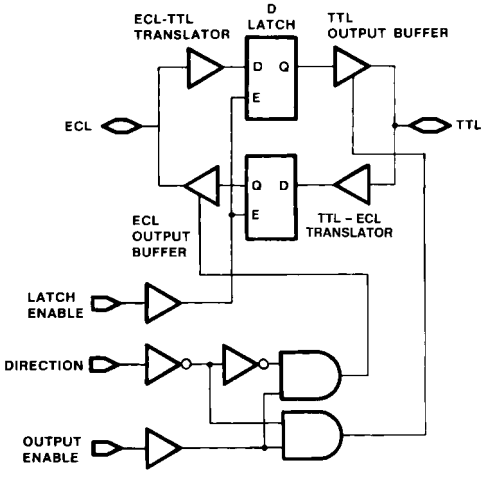
Note 4: Latch is transparent.

Functional Diagram



Note: LE, DIR, and OE use ECL logic levels

Detail



Absolute Maximum Ratings (Note 5)

Storage Temperature (T_{STG})	−65°C to +150°C
Maximum Junction Temperature (T_J)	+150°C
V_{EE} Pin Potential to Ground Pin	−7.0V to +0.5V
V_{TTL} Pin Potential to Ground Pin	−0.5V to +6.0V
ECL Input Voltage (DC)	V_{EE} to +0.5V
ECL Output Current	
(DC Output HIGH)	−50 mA
TTL Input Voltage (Note 6)	−0.5V to +6.0V
TTL Input Current (Note 6)	−30 mA to +5.0 mA
Voltage Applied to Output	
in HIGH State	
3-STATE Output	−0.5V to +5.5V
Current Applied to TTL	
Output in LOW State (Max)	twice the rated I_{OL} (mA)
ESD (Note 7)	≥2000V

Recommended Operating Conditions

Case Temperature (T_C)	
Commercial	0°C to +85°C
Industrial	−40°C to +85°C
ECL Supply Voltage (V_{EE})	−5.7V to −4.2V
TTL Supply Voltage (V_{TTL})	+4.5V to +5.5V

Note 5: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 6: Either voltage limit or current limit is sufficient to protect inputs.

Note 7: ESD testing conforms to MIL-STD-883, Method 3015.

Commercial Version

TTL-to-ECL DC Electrical Characteristics (Note 8)

V_{EE} = −4.2V to −5.7V, V_{CC} = V_{CCA} = GND, T_C = 0°C to +85°C, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	Min	Typ	Max	Units	Conditions
V_{OH}	Output HIGH Voltage	−1025	−955	−870	mV	V_{IN} = $V_{IH(Max)}$ or $V_{IL(Min)}$
V_{OL}	Output LOW Voltage	−1830	−1705	−1620	mV	Loading with 50Ω to − 2V
	Cutoff Voltage		−2000	−1950	mV	OE or DIR LOW, V_{IN} = $V_{IH(Max)}$ or $V_{IL(Min)}$, Loading with 50Ω to −2V
V_{OHC}	Output HIGH Voltage Corner Point HIGH	−1035			mV	V_{IN} = $V_{IH(Min)}$ or $V_{IL(Max)}$ Loading with 50Ω to −2V
V_{OLC}	Output LOW Voltage Corner Point LOW			−1610	mV	
V_{IH}	Input HIGH Voltage	2.0		5.0	V	Over V_{TTL}, V_{EE}, T_C Range
V_{IL}	Input LOW Voltage	0		0.8	V	Over V_{TTL}, V_{EE}, T_C Range
I_{IH}	Input HIGH Current			70	µA	V_{IN} = +2.7V
	Breakdown Test			1.0	mA	V_{IN} = +5.5V
I_{IL}	Input LOW Current	−700			µA	V_{IN} = +0.5V
V_{FCD}	Input Clamp Diode Voltage	−1.2			V	I_{IN} = −18 mA
I_{EE}	V_{EE} Supply Current					LE LOW, OE and DIR HIGH Inputs OPEN
		−159		−75	mA	V_{EE} = −4.2V to −4.8V
		−169		−75		V_{EE} = −4.2V to −5.7V

Note 8: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

Commercial Version (Continued)

ECL-to-TTL DC Electrical Characteristics (Note 9)

V_{EE} = −4.2V to −5.7V, V_{CC} = V_{CCA} = GND, T_C = 0°C to +85°C, C_L = 50 pF, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	Min	Typ	Max	Units	Conditions
V_{OH}	Output HIGH Voltage	2.7	3.1		V	I_{OH} = −3 mA, V_{TTL} = 4.75V
		2.4	2.9			I_{OH} = −3 mA, V_{TTL} = 4.50V
V_{OL}	Output LOW Voltage		0.3	0.5	V	I_{OL} = 24 mA, V_{TTL} = 4.50V
V_{IH}	Input HIGH Voltage	−1165		−870	mV	Guaranteed HIGH Signal for All Inputs
V_{IL}	Input LOW Voltage	−1830		−1475	mV	Guaranteed LOW Signal for All Inputs
I_{IH}	Input HIGH Current			350	µA	V_{IN} = V_{IH} (Max)
I_{IL}	Input LOW Current	0.50			µA	V_{IN} = V_{IL} (Min)
I_{OZHT}	3-STATE Current Output HIGH			70	µA	V_{OUT} = +2.7V
I_{OZLT}	3-STATE Current Output LOW	−700			µA	V_{OUT} = +0.5V
I_{OS}	Output Short-Circuit Current	−150		−60	mA	V_{OUT} = 0.0V, V_{TTL} = +5.5V
I_{TTL}	V_{TTL} Supply Current			74	mA	TTL Outputs LOW
				49	mA	TTL Outputs HIGH
				67	mA	TTL Outputs in 3-STATE

DIP TTL-to-ECL AC Electrical Characteristics (Note 9)

V_{EE} = −4.2V to −5.7V, V_{TTL} = +4.5V to +5.5V, V_{CC} = V_{CCA} = GND

Symbol	Parameter	T_C = 0°C		T_C = 25°C		T_C = 85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	T_N to E_n (Transparent)	1.1	3.5	1.1	3.6	1.1	3.8	ns	Figures 1, 2
t_{PLH} t_{PHL}	LE to E_n	1.7	3.6	1.7	3.7	1.9	3.9	ns	Figures 1, 2
t_{PZH}	OE to E_n (Cutoff to HIGH)	1.3	4.2	1.5	4.4	1.7	4.8	ns	Figures 1, 2
t_{PHZ}	OE to E_n (HIGH to Cutoff)	1.5	4.5	1.6	4.5	1.6	4.6	ns	Figures 1, 2
t_{PHZ}	DIR to E_n (HIGH to Cutoff)	1.6	4.3	1.6	4.3	1.7	4.5	ns	Figures 1, 2
t_{SET}	T_n to LE	1.1		1.1		1.1		ns	Figures 1, 2
t_{HOLD}	T_n to LE	1.1		1.1		1.1		ns	Figures 1, 2
t_{PW}(H)	Pulse Width LE	2.1		2.1		2.1		ns	Figures 1, 2
t_{TLH} t_{THL}	Transition Time 20% to 80%, 80% to 20%	0.6	1.6	0.6	1.6	0.6	1.6	ns	Figures 1, 2

Note 9: The specified limits represent the "worst" case value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

Commercial Version (Continued)

DIP ECL-to-TTL AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{TTL} = +4.5V to +5.5V, V_{CC} = V_{CCA} = GND, C_L = 50 pF

Symbol	Parameter	T_C = 0°C		T_C = 25°C		T_C = 85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	E_n to T_n (Transparent)	2.3	5.6	2.4	5.6	2.6	5.9	ns	Figures 3, 4
t_{PLH} t_{PHL}	LE to T_n	3.1	7.2	3.1	7.2	3.3	7.7	ns	Figures 3, 4
t_{PZH} t_{PZL}	OE to T_n (Enable Time)	3.4 3.8	8.45 9.2	3.7 4.0	8.95 9.2	4.0 4.3	9.7 9.95	ns	Figures 3, 5
t_{PHZ} t_{PLZ}	OE to T_n (Disable Time)	3.2 3.0	8.95 7.7	3.3 3.4	8.95 8.7	3.5 4.1	9.2 9.95	ns	Figures 3, 5
t_{PHZ} t_{PLZ}	DIR to T_n (Disable Time)	2.7 2.8	8.2 7.45	2.8 3.1	8.7 7.95	3.1 4.0	8.95 9.2	ns	Figures 3, 6
t_{SET}	E_n to LE	1.1		1.1		1.1		ns	Figures 3, 6
t_{HOLD}	E_n to LE	2.1		2.1		2.6		ns	Figures 3, 4
t_{PW}(H)	Pulse Width LE	4.1		4.1		4.1		ns	Figures 3, 7

SOIC and PLCC TTL-to-ECL AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = 0°C		T_C = 25°C		T_C = 85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	T_n to E_n (Transparent)	1.1	3.3	1.1	3.4	1.1	3.6	ns	Figures 1, 2
t_{PLH} t_{PHL}	LE to E_n	1.7	3.4	1.7	3.5	1.9	3.7	ns	Figures 1, 2
t_{PZH}	OE to E_n (Cutoff to HIGH)	1.3	4.0	1.5	4.2	1.7	4.6	ns	Figures 1, 2
t_{PHZ}	OE to E_n (HIGH to Cutoff)	1.5	4.3	1.6	4.3	1.6	4.4	ns	Figures 1, 2
t_{PHZ}	DIR to E_n (HIGH to Cutoff)	1.6	4.1	1.6	4.1	1.7	4.3	ns	Figures 1, 2
t_{SET}	T_n to LE	1.0		1.0		1.0		ns	Figures 1, 2
t_{HOLD}	T_n to LE	1.0		1.0		1.0		ns	Figures 1, 2
t_{PW}(H)	Pulse Width LE	2.0		2.0		2.0		ns	Figures 1, 2
t_{TLH} t_{THL}	Transition Time 20% to 80%, 80% to 20%	0.6	1.6	0.6	1.6	0.6	1.6	ns	Figures 1, 2
t_{OSHL}	Maximum Skew Common Edge Output-to-Output Variation Data to Output Path		200		200		200	ps	PLCC Only (Note 10)
t_{OSLH}	Maximum Skew Common Edge Output-to-Output Variation Data to Output Path		200		200		200	ps	PLCC Only (Note 10)
t_{OST}	Maximum Skew Opposite Edge Output-to-Output Variation Data to Output Path		650		650		650	ps	PLCC Only (Note 10)
t_{PS}	Maximum Skew Pin (Signal) Transition Variation Data to Output Path		650		650		650	ps	PLCC Only (Note 10)

Note 10: Output-to-Output Skew is defined as the absolute value of the difference between the actual propagation delay for any outputs within the same packaged device. The specifications apply to any outputs switching in the same direction either HIGH-to-LOW (t_{OSHL}), or LOW-to-HIGH (t_{OSLH}), or in opposite directions both HL and LH (t_{OST}). Parameters t_{OST} and t_{ps} guaranteed by design.

Commercial Version (Continued)
SOIC and PLCC ECL-to-TTL AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{TTL} = +4.5V to +5.5V, C_L = 50 pF

Symbol	Parameter	T_C = 0°C		T_C = 25°C		T_C = 85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	E_n to T_n (Transparent)	2.3	5.4	2.4	5.4	2.6	5.7	ns	Figures 3, 4
t_{PLH} t_{PHL}	LE to T_n	3.1	7.0	3.1	7.0	3.3	7.5	ns	Figures 3, 4
t_{PZH} t_{PZL}	OE to T_n (Enable Time)	3.4 3.8	8.25 9.0	3.7 4.0	8.75 9.0	4.0 4.3	9.5 9.75	ns	Figures 3, 5
t_{PHZ} t_{PLZ}	OE to T_n (Disable Time)	3.2 3.0	8.75 7.5	3.3 3.4	8.75 8.5	3.5 4.1	9.0 9.75	ns	Figures 3, 5
t_{PHZ} t_{PLZ}	DIR to T_n (Disable Time)	2.7 2.8	8.0 7.25	2.8 3.1	8.5 7.75	3.1 4.0	8.75 9.0	ns	Figures 3, 6
t_{SET}	E_n to LE	1.0		1.0		1.0		ns	Figures 3, 4
t_{HOLD}	E_n to LE	2.0		2.0		2.5		ns	Figures 3, 4
t_{PW}(H)	Pulse Width LE	4.0		4.0		4.0		ns	Figures 3, 4
t_{OSHL}	Maximum Skew Common Edge Output-to-Output Variation Data to Output Path		600		600		600	ps	PLCC Only (Note 11)
t_{OSLH}	Maximum Skew Common Edge Output-to-Output Variation Data to Output Path		850		850		850	ps	PLCC Only (Note 11)
t_{OST}	Maximum Skew Opposite Edge Output-to-Output Variation Data to Output Path		1350		1350		1350	ps	PLCC Only (Note 11)
t_{PS}	Maximum Skew Pin (Signal) Transition Variation Data to Output Path		950		950		950	ps	PLCC Only (Note 11)

Note 11: Output-to-Output Skew is defined as the absolute value of the difference between the actual propagation delay for any outputs within the same packaged device. The specifications apply to any outputs switching in the same direction either HIGH-to-LOW (t_{OSHL}), or LOW-to-HIGH (t_{OSLH}), or in opposite directions both HL and LH (t_{OST}). Parameters t_{OST} and t_{PS} guaranteed by design.

Industrial Version

PLCC TTL-to-ECL DC Electrical Characteristics (Note 12)

V_{EE} = −4.2V to −5.7V, V_{CC} = V_{CCA} = GND, T_C = −40°C to +85°C, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = −40°C		T_C = 0°C to +85°C		Units	Conditions
		Min	Max	Min	Max		
V_{OH}	Output HIGH Voltage	−1085	−870	−1025	−870	mV	V_{IN} = $V_{IH(Max)}$ or $V_{IL(Min)}$
V_{OL}	Output LOW Voltage	−1830	−1575	−1830	−1620	mV	Loading with 50Ω to −2V
	Cutoff Voltage		−1900		−1950	mV	OE or DIR LOW, V_{IN}= $V_{IH(Max)}$ or $V_{IL(Min)}$, Loading with 50Ω to −2V
V_{OHC}	Output HIGH Voltage Corner Point HIGH	−1095		−1035		mV	V_{IN} = $V_{IH(Min)}$ or $V_{IL(Max)}$ Loading with 50Ω to −2V
V_{OLC}	Output LOW Voltage Corner Point LOW		−1565		−1610	mV	
V_{IH}	Input HIGH Voltage	2.0	5.0	2.0	5.0	V	Over V_{TTL}, V_{EE}, T_C Range
V_{IL}	Input LOW Voltage	0	0.8	0	0.8	V	Over V_{TTL}, V_{EE}, T_C Range
I_{IH}	Input HIGH Current		70		70	µA	V_{IN} = +2.7V
	Breakdown Test		1.0		1.0	mA	V_{IN} = +5.5V
I_{IL}	Input LOW Current	−700		−700		µA	V_{IN} = +0.5V
V_{FCD}	Input Clamp Diode Voltage	−1.2		−1.2		V	I_{IN} = −18 mA
I_{EE}	V_{EE} Supply Current						LE LOW, OE and DIR HIGH Inputs OPEN
		−159	−70	−159	−75	mA	V_{EE} = −4.2V to −4.8V
		−169	−70	−169	−75		V_{EE} = −4.2V to −5.7V

PLCC ECL-to-TTL DC Electrical Characteristics (Note 12)

V_{EE} = −4.2V to −5.7V, V_{CC} = V_{CCA} = GND, T_C = −40°C to +85°C, C_L = 50 pF, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = −40°C		T_C = 0°C to +85°C		Units	Conditions
		Min	Max	Min	Max		
V_{OH}	Output HIGH Voltage	2.7		2.7		V	I_{OH} = −3 mA, V_{TTL} = 4.75V
		2.4		2.4			I_{OH} = −3 mA, V_{TTL} = 4.50V
V_{OL}	Output LOW Voltage		0.5		0.5	V	I_{OL} = 24 mA, V_{TTL} = 4.50V
V_{IH}	Input HIGH Voltage	−1170	−870	−1165	−870	mV	Guaranteed HIGH Signal for All Inputs
V_{IL}	Input LOW Voltage	−1830	−1480	−1830	−1475	mV	Guaranteed LOW Signal for All Inputs
I_{IH}	Input HIGH Current		425		350	µA	V_{IN} = V_{IH} (Max)
I_{IH}	Input LOW Current	0.50		0.50		µA	V_{IN} = V_{IH} (Min)
I_{OZHT}	3-STATE Current Output HIGH		70		70	µA	V_{OUT} = +2.7V
I_{OZLT}	3-STATE Current Output LOW	−700		−700		µA	V_{OUT} = +0.5V
I_{OS}	Output Short-Circuit Current	−150	−60	−150	−60	mA	V_{OUT} = 0.0V, V_{TTL} = +5.5V
I_{TTL}	V_{TTL} Supply Current		74		74		TTL Outputs LOW
			49		49	mA	TTL Outputs HIGH
			67		67		TTL Outputs in 3-STATE

Note 12: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

Industrial Version (Continued)

PLCC TTL-to-ECL AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{TTL} = +4.5V to +5.5V

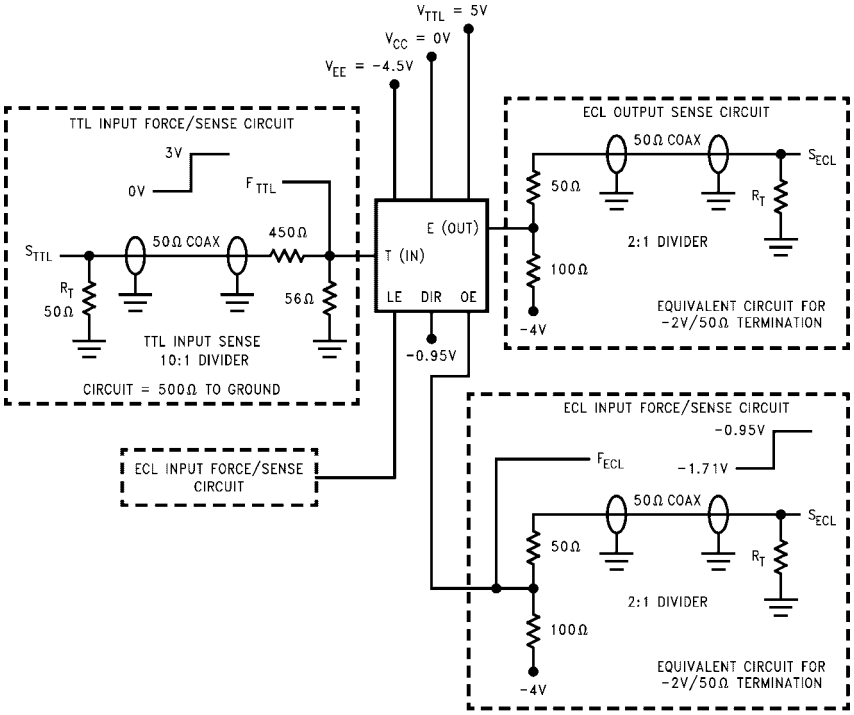
Symbol	Parameter	T_C = −40°C		T_C = 25°C		T_C = 85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	T_n to E_n (Transparent)	1.0	3.3	1.1	3.4	1.1	3.6	ns	Figures 1, 2
t_{PLH} t_{PHL}	LE to E_n	1.7	3.4	1.7	3.5	1.9	3.7	ns	Figures 1, 2
t_{PZH}	OE to E_n (Cutoff to HIGH)	1.2	4.0	1.5	4.2	1.7	4.6	ns	Figures 1, 2
t_{PHZ}	OE to E_n (HIGH to Cutoff)	1.5	4.5	1.6	4.3	1.6	4.4	ns	Figures 1, 2
t_{PHZ}	DIR to E_n (HIGH to Cutoff)	1.6	4.1	1.6	4.1	1.7	4.3	ns	Figures 1, 2
t_{SET}	T_n to LE	2.5		1.0		1.0		ns	Figures 1, 2
t_{HOLD}	T_n to LE	1.0		1.0		1.0		ns	Figures 1, 2
t_{PW}(H)	Pulse Width LE	2.5		2.0		2.0		ns	Figures 1, 2
t_{TLH} t_{THL}	Transition Time 20% to 80%, 80% to 20%	0.4	2.3	0.6	1.6	0.6	1.6	ns	Figures 1, 2

PLCC ECL-to-TTL AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{TTL} = +4.5V to +5.5V, C_L = 50 pF

Symbol	Parameter	T_C = 0°C		T_C = 25°C		T_C = 85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	E_n to T_n (Transparent)	2.3	5.4	2.4	5.4	2.6	5.7	ns	Figures 3, 4
t_{PLH} t_{PHL}	LE to T_n	3.1	7.4	3.1	7.0	3.3	7.5	ns	Figures 3, 4
t_{PZH}	OE to T_n	3.4	8.3	3.7	8.75	4.0	9.5	ns	Figures 3, 5
t_{PZL}	(Enable Time)	3.7	9.0	4.0	9.0	4.3	9.75		
t_{PHZ}	OE to T_n	3.2	9.0	3.3	8.75	3.5	9.0	ns	Figures 3, 5
t_{PLZ}	(Disable Time)	3.0	7.5	3.4	8.5	4.1	9.75		
t_{PHZ}	DIR to T_n	2.7	8.0	2.8	8.5	3.1	8.75	ns	Figures 3, 5
t_{PLZ}	(Disable Time)	2.8	7.3	3.1	7.75	4.0	9.0		
t_{SET}	E_n to LE	2.5		1.0		1.0		ns	Figures 3, 4
t_{HOLD}	E_n to LE	2.3		2.0		2.5		ns	Figures 3, 4
t_{PW}(H)	Pulse Width LE	4.0		4.0		4.0		ns	Figures 3, 4

Test Circuitry (TTL-to-ECL)



Note:

- R_t = 50Ω termination. When an input or output is being monitored by a scope, R_t is supplied by the scope's 50Ω resistance. When an input or output is not being monitored, an external 50Ω resistance must be applied to serve as R_t.
- TTL and ECL force signals are brought to the DUT via 50Ω coax lines.
- V_{TTL} is decoupled to ground with 0.1 µF to ground, V_{EE} is decoupled to ground with 0.01 µF and V_{CC} is connected to ground.
- For ECL input pins, the equivalent force/sense circuitry is optional.

FIGURE 1. TTL-to-ECL AC Test Circuit

Switching Waveforms (TTL-to-ECL)

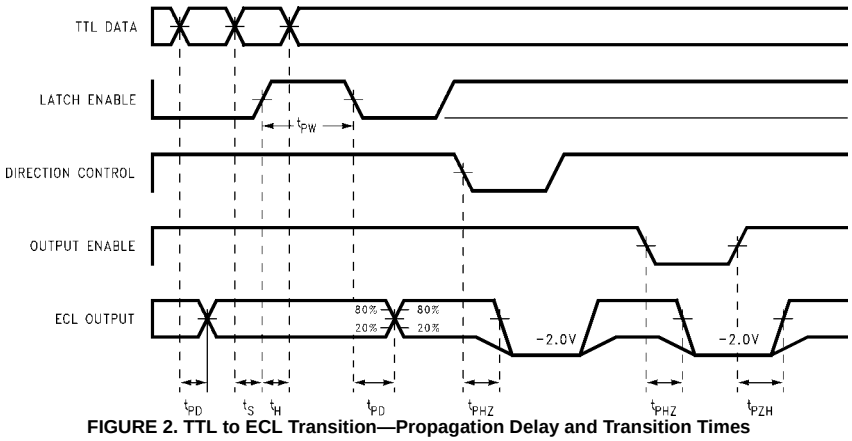
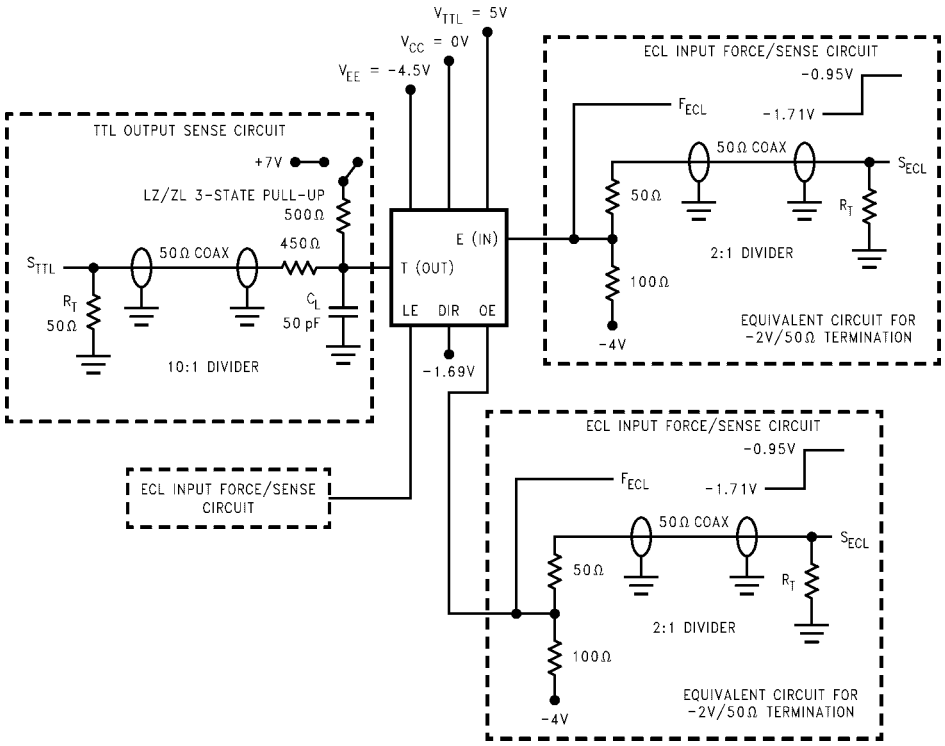


FIGURE 2. TTL to ECL Transition—Propagation Delay and Transition Times

Test Circuitry (ECL-to-TTL)

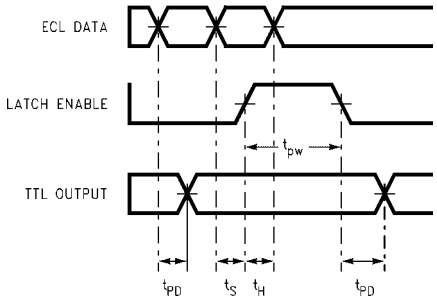


Note:

- R_t = 50Ω termination. When an input or output is being monitored by a scope, R_t is supplied by the scope's 50Ω resistance. When an input or output is not being monitored, an external 50Ω resistance must be applied to serve as R_t.
- The TTL 3-State pull up switch is connected to +7V only for ZL and LZ tests.
- TTL and ECL force signals are brought to the DUT via 50Ω coax lines.
- V_{TTL} is decoupled to ground with 0.1 µF, V_{EE} is decoupled to ground with 0.01 µF and V_{CC} is connected to ground.

FIGURE 3. ECL-to-TTL AC Test Circuit

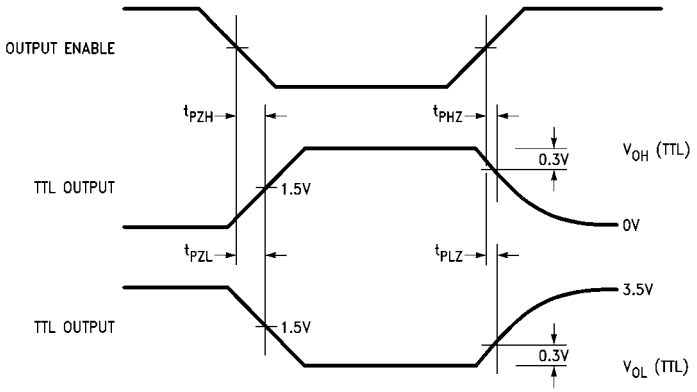
Switching Waveforms (ECL-to-TTL)



Note: DIR is LOW, and OE is HIGH

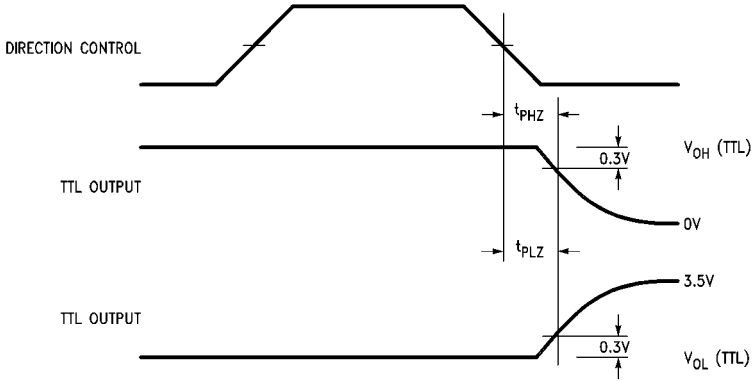
FIGURE 4. ECL-to-TTL Transition—Propagation Delay and Transition Times

Switching Waveforms (ECL-to-TTL) (Continued)



Note: DIR is LOW, LE is HIGH

FIGURE 5. ECL-to-TTL Transition, OE to TTL Output, Enable and Disable Times



Note: OE is HIGH, LE is HIGH

FIGURE 6. ECL-to-TTL Transition, DIR to TTL Output, Disable Time

Applications

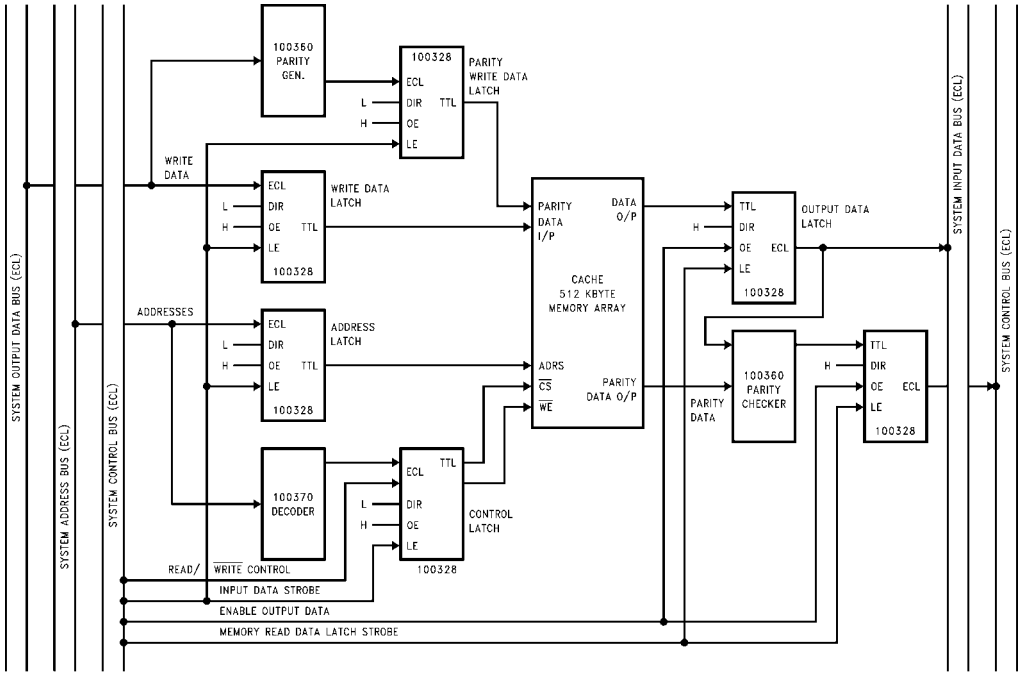
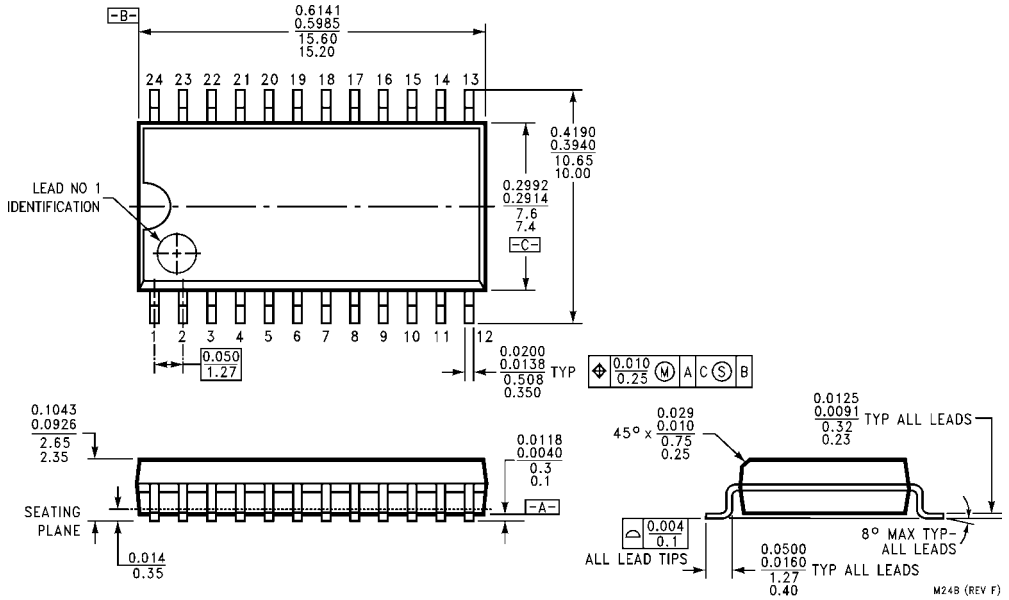
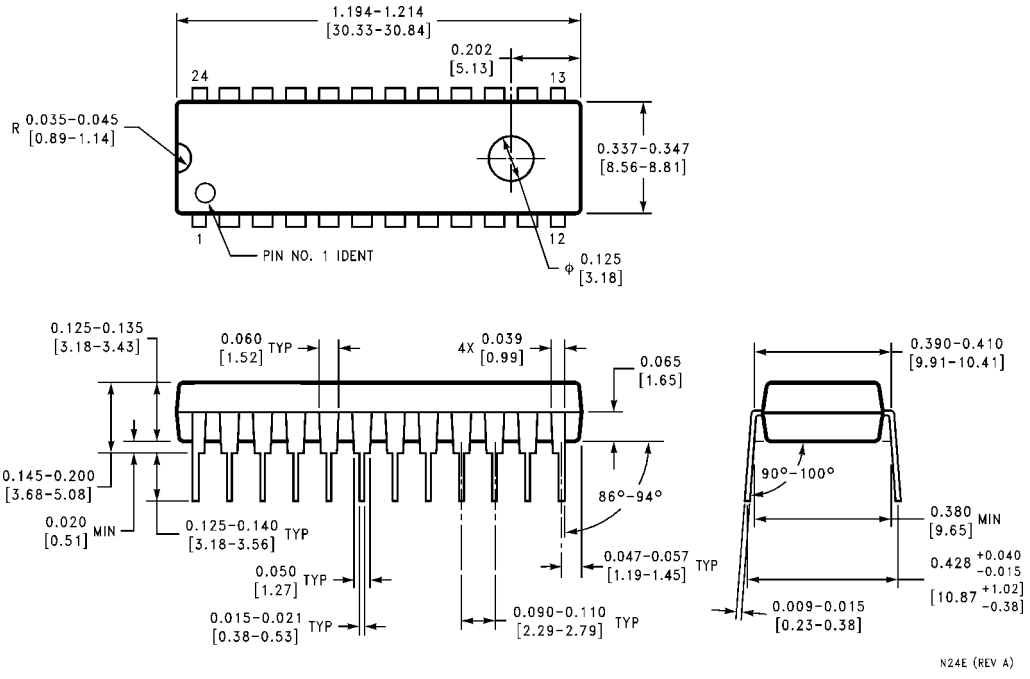


FIGURE 7. Applications Diagram—MOS/TTL SRAM Interface Using 100328 ECL–TTL Latched Translator

Physical Dimensions inches (millimeters) unless otherwise noted

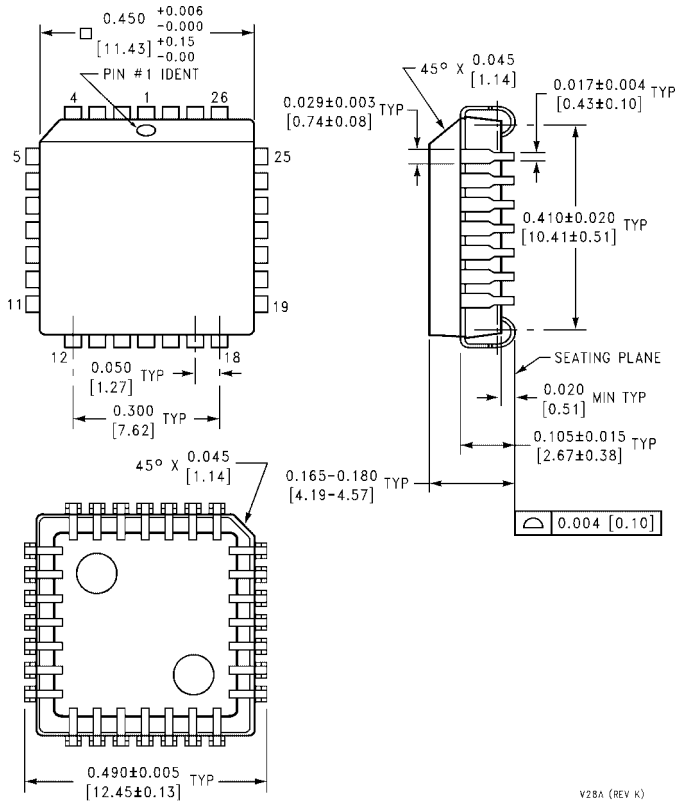


24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
Package Number M24B



24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-010, 0.400 Wide
Package Number N24E

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square
Package Number V28A